



Infineon Technologies Key Facts

Headquarters:	Munich, Germany
Regional business units:	Americas: San Jose, California Asia Pacific: Singapore Japan: Tokyo
Fiscal year 2001 revenues: (ending September 2001)	Euro 5.67 billion
Employees (September 2001):	About 33,800
Market position in 2000:	World's tenth-largest semiconductor manufacturer (by sales; according to Dataquest; status: 12/2000)
Main areas of activity:	Chips for Wireless Communication (No. 1 in high-frequency components) Chips for Communication and Peripherals (No. 1 in ISDN) Automotive and Industrial electronics (No. 2 in automotive segment without car radio) ICs for Security and Chip Card applications (No. 1 in chip card segment) Memory Components (leading in 300-millimeter technology, No. 4 in DRAM products)
Manufacturing:	Nine wafer factories (frontend fab) including state-of-the-art DRAM manufacturing on three continents (Europe, USA, Asia) 13 sites for assembly and testing (backend)

Research & Development: 29 market and customer-oriented development centers in nine countries

R&D expenditures: Euro 1.19 billion
(21 percent of total revenues in fiscal year 2001)

Strategic partnerships:

- IBM
(technology development, joint manufacturing in France)
- UMC
(technology development for building logic chips, joint production in Singapore)
- Mosel Vitelic
(joint manufacturing of memory products in Taiwan)
- Toshiba
(technology development)

Ticker symbol: IFX; the company is listed on the DAX index of the Frankfurt Stock Exchange and on the New York Stock Exchange

For further information visit our web site at www.infineon.com